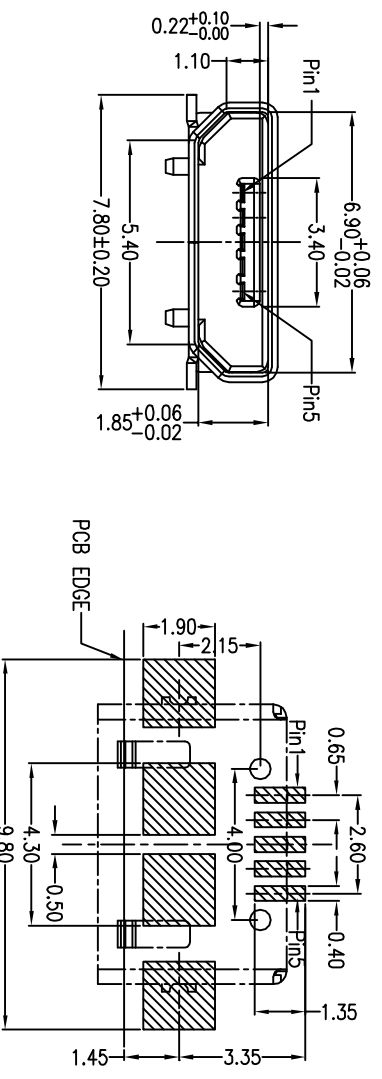
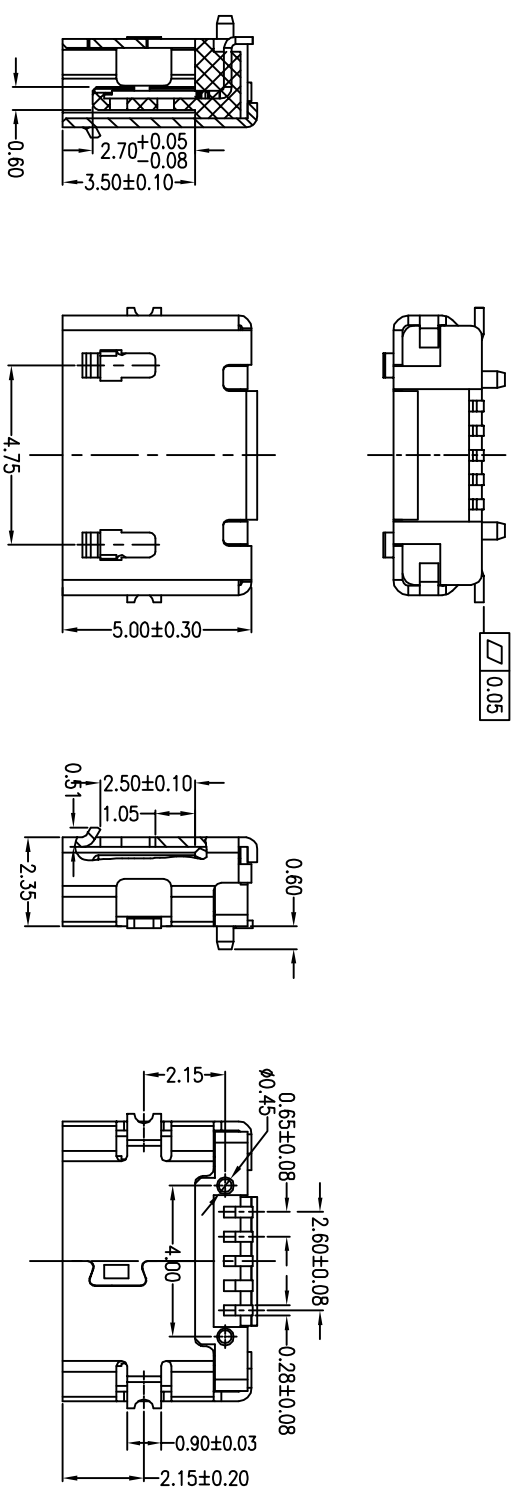


REV.	ECH NO	LOCATIONS	DESCRIPTION	DATE



RECOMMENDED PCB LAYOUT

- Note:
1. Material:
- 1.1 Housing: High temperature thermoplastic with g.f, UL94V-0
 - 1.2 Contact: copper alloy, t=0.20mm
 - 1.3 Shell: copper alloy, t=0.25mm
2. Specification:
- 2.1 Current rating: 1 A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 50 mW Max.
 - 2.4 Insulation resistance: 100 MW Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min. 0.81~2.05 Kgf Min.
 - 2.7 Temperature range: -30°C~80°C

A 01 S B 1 4 1 B 2-274

- ① 产品代号 A: 产品
- ② 产品系列 01: micro usb Bpin
- ③ 产品类别 S: 母座
- ④ 产品类型 B: B TYPE
- ⑤ 外壳材料 1: 0280R-H
- ⑥ 端子材质 4: 0510R-BH
- ⑦ 主体材质 1: 1.0P
- ⑧ 主体颜色 B: 黑色
- ⑨ 下板类型 2: 2.0mm
- ⑩ 细节流水 274: Micro usb B Type Smt有柱有后盖无翻边

PART NO:	A01SB141B2-274	MATERIAL:	SEE NOTE
MODEL NO:	XX	FINISH:	SEE NOTE
UNIT:	MM	SIZE:	A4
TOLERANCE UNSPECIFIED	.x	DR:	夏友红
.xx	0.25	CHK:	
.xxx	0.20	APP:	
Ang.	0.15	SCALE:	5:1
	2"	DATE:	2012.06.06
		REV:	A

深圳市山谷道电子有限公司
电话: 0755-27759859 传真: 0755-27759850

TITLE: Micro usb 5s B Type Smt有柱有后盖无翻边

DWG NO: A274

